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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET

BIPOLAR ANALOG INTEGRATED CIRCUIT μPC8233TK

SiGe:C LOW NOISE AMPLIFIER FOR GPS/MOBILE COMMUNICATIONS

DESCRIPTION

The μ PC8233TK is a silicon germanium carbon (SiGe:C) monolithic integrated circuit designed as low noise amplifier for GPS and mobile communications. This device exhibits low noise figure and high power gain characteristics. This device is enabled in the frequency range from 1.5 to 2.4 GHz by modifying the external matching circuit.

This device is suitable for the reduction in power consumption of the mobile communication system because it operates by low voltage and low current.

The package is 6-pin lead-less minimold, suitable for surface mount.

This IC is manufactured using our UHS4 (Ultra High Speed Process) SiGe:C bipolar process.

FEATURES

٠	Supply voltage	: Vcc = 1.6 to 3.3 V (2.7 V TYP.)
٠	Low noise	: NF = 0.90 dB TYP. @ Vcc = 2.7 V, fin = 1 575 MHz
		NF = 0.90 dB TYP. @ Vcc = 1.8 V, fin = 1 575 MHz

High gain

•

- Low current consumption
- : Icc = 3.5 mA TYP. @ Vcc = 2.7 V : VPSon = 1.0 V to VCC, VPSoff = 0.0 to 0.4 V
- Built-in power-saving function High-density surface mounting •
 - : 6-pin lead-less minimold package $(1.5 \times 1.1 \times 0.55 \text{ mm})$

: GP = 20 dB TYP. @ Vcc = 2.7 V, fin = 1 575 MHz GP = 19.5 dB TYP. @ Vcc = 1.8 V, fin = 1 575 MHz

- Included very robust bandgap regulator (Small Vcc and TA dependence)
- Included protection circuits for ESD

APPLICATION

Low noise amplifier for GPS and mobile communications

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μΡC8233TK-E2	μΡC8233TK-E2-A	6-pin lead-less minimold (1511 PKG) (Pb-Free)	6P	8 mm wide embossed tapingPin 1, 6 face the perforation side of the tapeQty 5 kpcs/reel

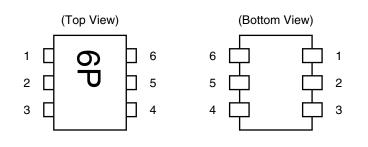
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μ PC8233TK

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

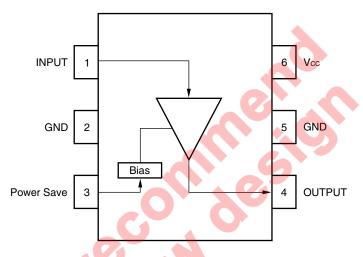
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PIN CONNECTIONS



Pin No.	Pin Name	
1 INPUT		
2	GND	
3	Power Save	
4	OUTPUT	
5	GND	
6	Vcc	

INTERNAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	Vcc	TA = +25°C	4.0	V
Power-Saving Voltage	Vps	TA = +25°C	4.0	V
Power Dissipation	PD	T _A = +85°C Note	232	mW
Operating Ambient Temperature	ΤA		-40 to +85	°C
Storage Temperature	Tstg		–55 to +150	°C
Input Power	Pin		+10	dBm

Note Mounted on double-side copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	1.6	2.7	3.3	V
Operating Ambient Temperature	TA	-40	+25	+85	°C
Power Save Turn-on Voltage	VPSon	1.0	_	Vcc	V
Power Save Turn-off Voltage	VPSoff	0	_	0.4	V

ELECTRICAL CHARACTERISTICS

(TA = +25°C, Vcc = VPs = 2.7 V, fin = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	lcc	No Signal (VPs = 2.7 V)	2.5	3.5	4.8	mA
		At Power-Saving Mode (VPs = 0 V)	_	-	1	μA
Power Gain	G₽	P _{in} = -35 dBm	17.5	20.0	22.5	dB
Noise Figure	NF		-	0.9	1.2	dB
Input Return Loss	RLin		7	10	-	dB
Output Return Loss	RLout		10	16	-	dB

STANDARD CHARACTERISTICS FOR REFERENCE 1

(TA = +25°C, Vcc = VPs = 2.7 V, fin = 1 575 MHz, unless otherwise specified)

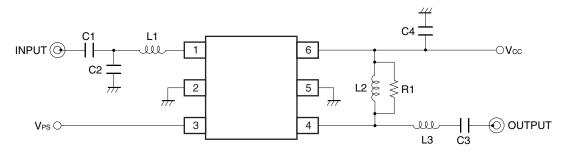
Parameter	Symbol	Test Conditions	Reference	Unit
Input 3rd Order Intercept Point	IIP₃	fin1 = 1 575 MHz, fin2 = 1 574 MHz	-8.5	dBm
Isolation	ISL		36	dB
Gain 1 dB Compression Input Power	Pin (1 dB)		-23	dBm

STANDARD CHARACTERISTICS FOR REFERENCE 2

(TA = +25°C, Vcc = VPs = 1.8 V, fin = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	Reference	Unit
Circuit Current	lcc	No Signal (VPs = 1.8 V)	3.3	mA
Power Gain	G₽	Pin = -35 dBm	19.5	dB
Noise Figure	NF		0.9	dB
Input 3rd Order Intercept Point	IIP₃	fin1 = 1 575 MHz, fin2 = 1 574 MHz	-9.5	dBm
Input Return Loss	RLin		9.5	dB
Output Return Loss	RLout		15.5	dB
Isolation	ISL		36	dB
Gain 1 dB Compression Input Power	Pin (1 dB)		-23.5	dBm

TEST CIRCUIT

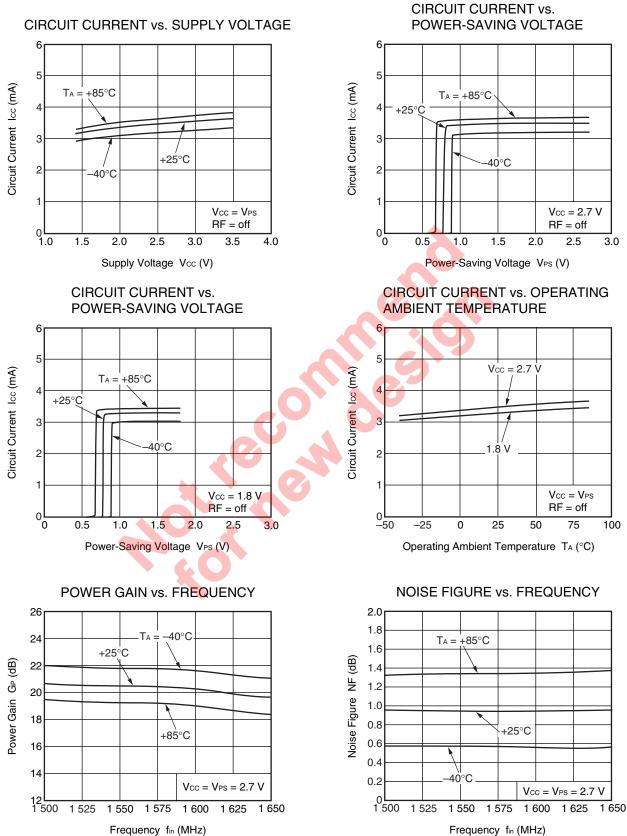


COMPONENT LIST

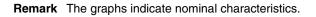
3.0

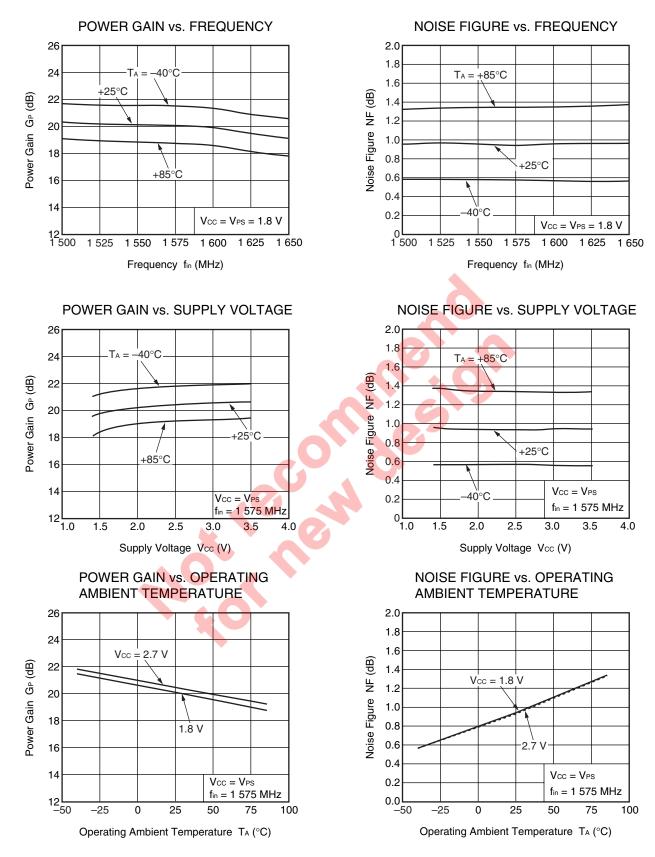
100

TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)



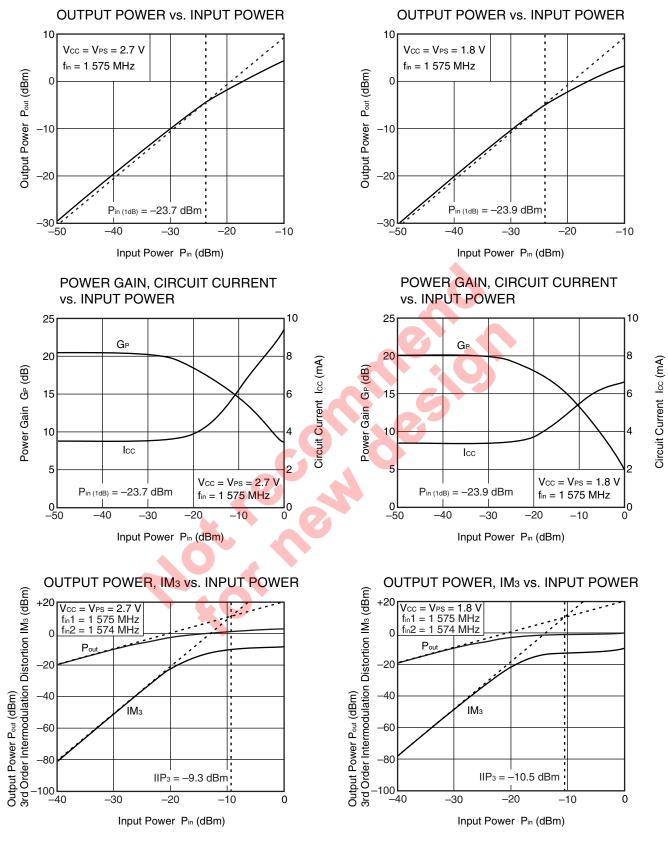
Frequency fin (MHz)



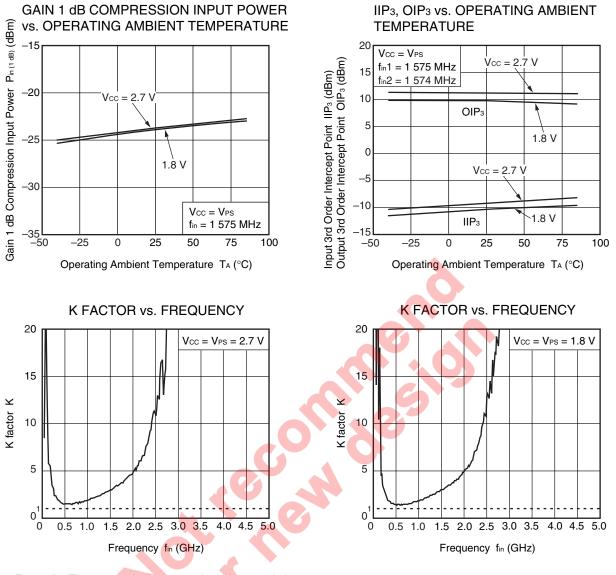


Remark The graphs indicate nominal characteristics.

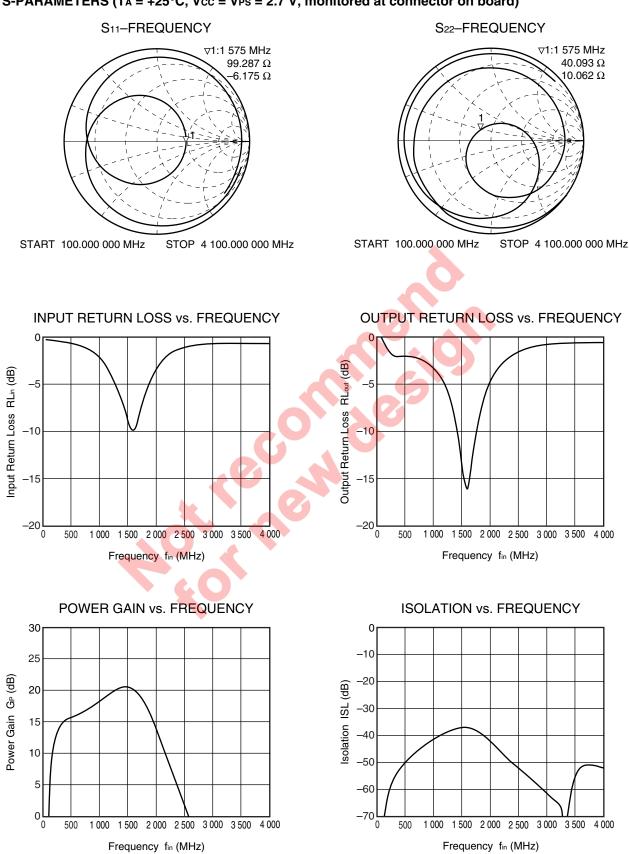




Remark The graphs indicate nominal characteristics.

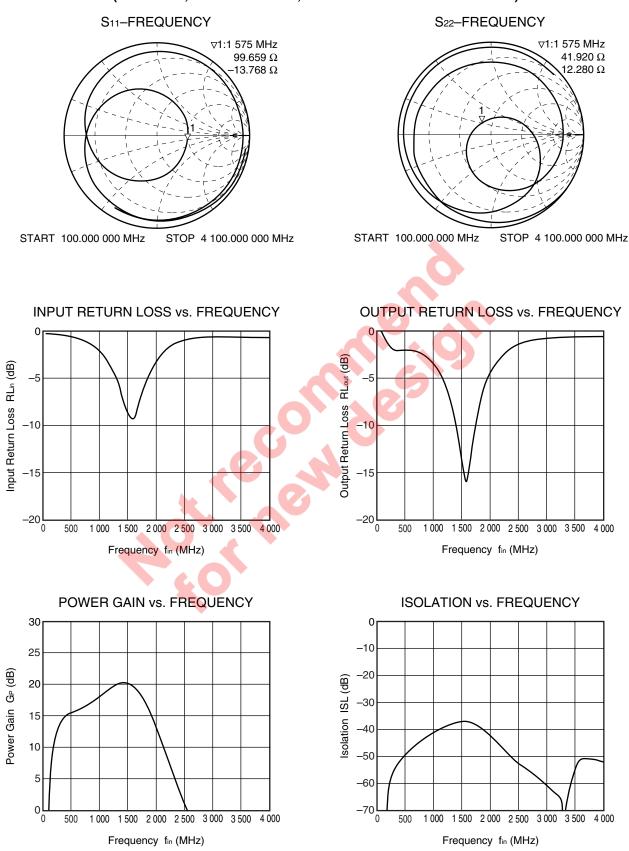


Remark The graphs indicate nominal characteristics.

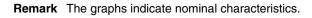


S-PARAMETERS (TA = +25°C, Vcc = VPs = 2.7 V, monitored at connector on board)

Remark The graphs indicate nominal characteristics.



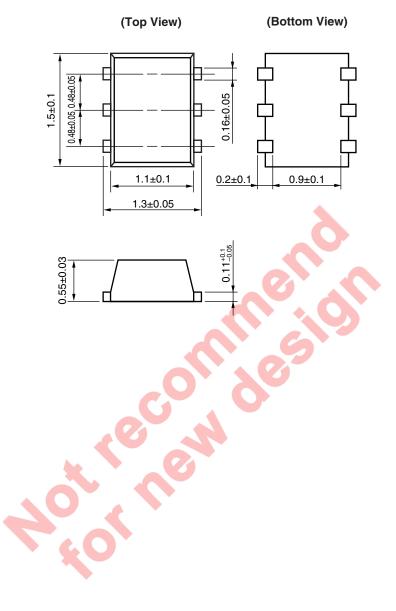
S-PARAMETERS (TA = +25°C, Vcc = VPs = 1.8 V, monitored at connector on board)



Data Sheet PU10706EJ01V0DS

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511 PKG) (UNIT: mm)



NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.
- (4) Do not supply DC voltage to INPUT pin.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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